

## Scintillation Materials, Detectors and Electronics

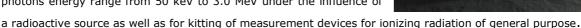
## **Product Data Sheet**

### SCINTILLATION ASSEMBLIES

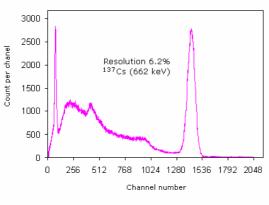
Scintillation assemblies based on NaI (TI), CsI (TI) and CsI (Na) are produced in different modifications. Scintillation assembly consists of a scintillation crystal optically connected with a photomultiplier tube (PMT) and hermetically packed in aluminum housing. Scintillation crystal is wrapped in reflector material for maximum light detection. The scintillation assemblies can be produced in low-background and ruggedized versions.

Scintillation assembly may include voltage divider, preamplifier, high voltage generator and other electronic modules according to the customer's requirements.

Scintillation assemblies based on alkali halide scintillators are used for registration and gamma radiation spectrometry in the photons energy range from 50 keV to 3.0 MeV under the influence of



The scintillation assemblies can be provided with PMTs of other types than specified. PMTs supplied by the customer can be used in the assembly. We develop custom-made assemblies according to customers' specification.



<sup>137</sup>Cs spectrum for a NaI (Tl) 76A76/3" (3x3")



## Additional information and features:

- production of any dimensions and design;
- aluminium or stainless steel containers;
- quartz or borosilicate protective glass for optical connection of scintillator and PMT;
- reflecting material with the highest characteristics;
- PMT individual matching and testing for each scintillator;
- using mu-metal magnetic shield for protection from external magnetic fields;



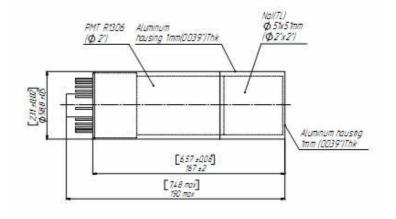
# Scintillation Materials, Detectors & Electronics

- integral or plug-in voltage divider, preamplifier, high voltage generator and other electronic modules for optimal operation;
- stability to the mechanical, climatic and temperature loads;
- ruggedized, demountable, low-background, x-ray and well-type versions are available;
- perfect scintillation parameters of products;
- products reliability confirmed by warranty.

#### **Popular configurations**

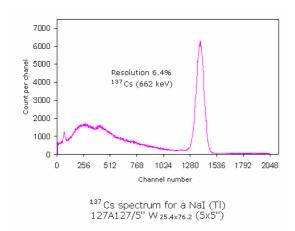
## Standard configurations

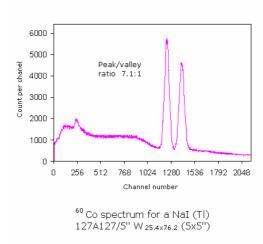
Crystal size, mm
(inches)
25x25 (1x1")
51x51 (2x2")
76x76 (3x3")
127x127 (5x5")
152x152 (6x6")



Model 51A51/2" (2x2")

A well-type receptacle in NaI (Tl) scintillation assemblies provides maximum absorption of radiation from a sample by approximating 4p geometry. Scintillation assemblies with well-type crystals are used in medicine, biological research, environmental monitoring, etc. We have different modifications of well-type scintillation assemblies in productions.





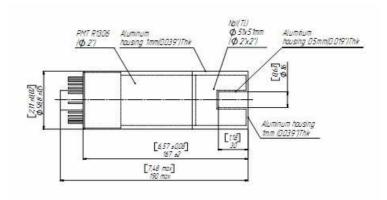
Product Data Sheet Scintillation Assemblies



# Scintillation Materials, Detectors & Electronics

### Axial well configurations

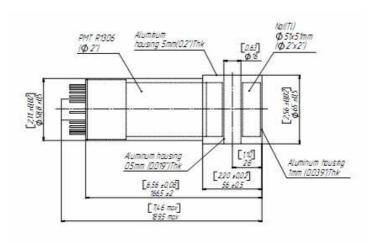
Crystal size, mm
(inches)
51x51 (2x2")
76x76 (3x3")
127x127 (5x5")



Model 51A51/2" W16x30 (2x2")

#### Lateral well configurations

Model	Crystal size, mm
	(inches)
51A51/2" P	51x51 (2x2")
76A76/3" P	76x76 (3x3")



Model 51A51/2" P<sub>16</sub> (2x2")

#### Ruggedized scintillation assemblies

Scintillation assemblies for geophysical (well logging) and special applications can be produced in ruggedized versions. Ruggedized scintillation assemblies with improved mechanical and thermal characteristics are applied for gamma-ray logging in gas and oil industry.

In order to provide increased mechanical and thermal hardness ruggedized scintillation assemblies are batched with NaI (TI) polycrystals or other scintillation materials, usually CsI (Na), with damping system for qualitative work within assemblies' lifetime.

## Low-background scintillation assemblies

For detection and spectrometry of weak ionizing radiation and low activity levels of different radionuclides, low-background scintillation assemblies are used which are characterized by a very low intrinsic background level. The low background is attained by the use of both crystals having a low intrinsic background level and suitable construction materials.

Product Data Sheet Page 3 of 3
Scintillation Assemblies September 2009